

Featured

- Side View PLCC 0.88mm SMD LED
- High Brightness
- AllnGaP / InGaN Technology
- High Reliability
- Clear Lens

Applications

- Consumer Electronics
- Wearables
- Automobile After Market
- Industrial Equipment

Description

The IN-P41TASRGB is a side view PLCC package RGB LED with high brightness and versatile design capabilities. It is a PLCC type LED which can be used in various applications.

Recommended Solder Pattern

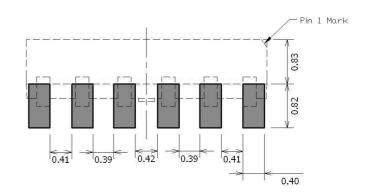
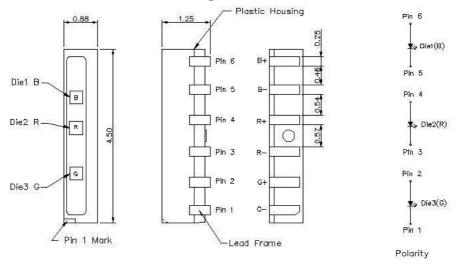


Figure 1. IN-P41TASRGB Solder Pattern

Package Dimensions in mm



Notes.

- All dimensions are in millimeters.
- 2. Tolerance is ± 0.10 mm unless otherwise noted

Figure 2. IN-P41TASRGB Package Dimensions

Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	P _d (mW)	I _F (mA)	I _{FP} * (mA)	V _R (V)	Top (°C)	T _{ST} (°C)
	Red	48	20	30	5	-40°C~+85°C	-40°C~+100°C
IN-P41TASRGB	Green	74	20	30	5	-40°C~+85°C	-40°C~+100°C
	Blue	74	20	30	5	-40°C~+85°C	-40°C~+100°C

Notes

1. Condition for IFP is pulse of 1/10 duty and 0.1msec width

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AllnGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

Electrical Characteristics T_A = 25℃ (Note 1)

Dradust	Emission		V _F (V)			λ(nm)		Viewing Angle	I*v(mcd)
Product	Color	I _F (mA)	typ.	max	λ _D	λ_{P}	Δλ	2 <i>H</i> 1/2	typ.
	Red	20	2.2	2.4	624	631	20	120	500
IN-P41TASRGB	Green	20	3.2	3.7	525	520	30	120	1200
	Blue	20	3.3	3.7	470	468	30	120	300

Notes

^{1.} Performance guaranteed only under conditions listed in above tables.



Luminous Intensity (Iv) Bin:

Color	Bin Code	Spec. Range
	U	360.0-450.0 mcd
R	V	450.0-560.0 mcd
K	w	560.0-715.0 mcd
	Х	715.0-900.0 mcd
	Y	900.0-1125.0 mcd
G	Z	1125.0-1440.0 mcd
	AA	1440.0-1800.0 mcd
	S	180.0-285.0 mcd
В	Т	285.0-360.0 mcd
	U	360.0-450.0 mcd

Note: It maintains a tolerance of ±10% on luminous intensity

Color Bin:

Color	Bin Code	Spec. Range				
R	Α	615.0-620.0 nm				
K	В	620.0-625.0 nm				
	С	625.0-630.0 nm				
	Α	515.0-520.0 nm				
0	В	520.0-525.0 nm				
G	С	525.0-530.0 nm				
	D	530.0-535.0 nm				
	В	464.0-468.0 nm				
В	С	468.0-472.0 nm				
	D	472.0-476.0 nm				

Note: It maintains a tolerance of ±0.5nm on color



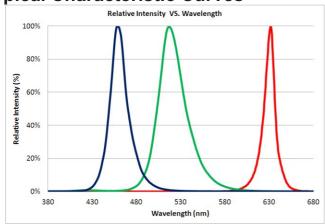
Forward Voltage (Vf) Bin:

Color	Bin Code	Spec. Range		
R	E18	1.6-2.4 V		
	G8	2.7-2.9 V		
	H7	2.9-3.1 V		
G&B	Н8	3.1-3.3 V		
	J7	3.3-3.5 V		
	J8	3.5-3.7 V		

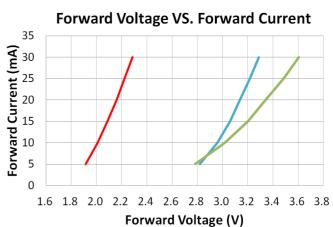
Note: It maintains a tolerance of ±0.05V on forward voltage measurements

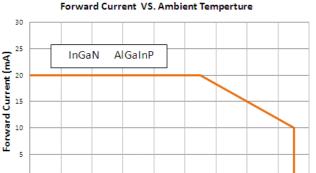


Typical Characteristic Curves

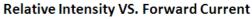


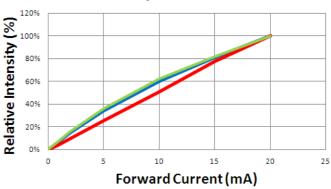






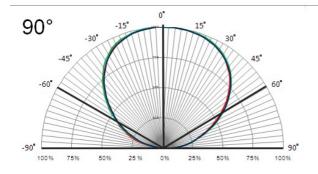
Ambient Temperture °C

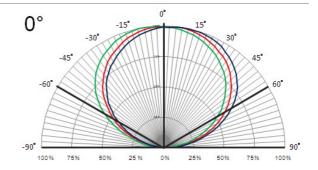




Typical Characteristic Curves – Radiation Pattern

Directive Characteristics





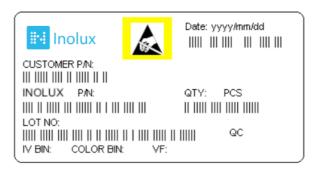


Ordering Information

Product	Emission Color	Technolog y	Test Current I _F (mA)	Luminous Intensity I _V (mcd) (Typ.)	Forward Voltage V _F (V) (Typ.)	Orderable Part Number
	Red	AllnGaP	20	500	2.2	
IN-P41TASRGB	Green	InGaN	20	1200	3.2	IN-P41TASRGB
	Blue	InGaN	20	300	3.3	



Label Specifications



Inolux P/N:

I	N	-	Р	4	1	Т	Α	S			R	G	В	-	Χ	Х	Х	Х
			Material	Pack	age	Variat	ion	Orientation	Current	Lens	Color	Color	Color			Custor Stam	mized p-off	
	blux MD		P = PLCC Type			5 x 1.25 Tri-chip	x	S = Side View	(Blank) = 20mA			G = 525nm	B = 470nm					

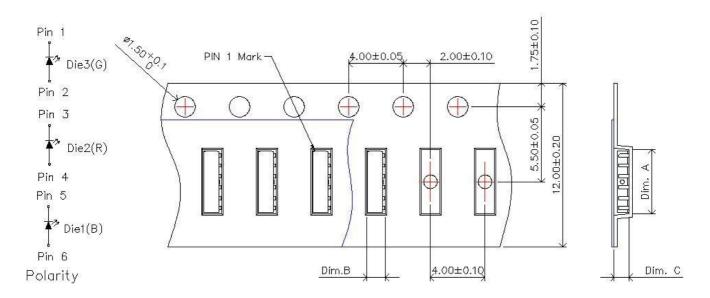
Lot No.:

Z	2	0	1	7	01	24	001
Internal		Voor (2017	, 2018,)		Month	Data	Serial
Tracker		real (2017	, 2010,)		IVIOITUI	Date	Seriai



Packaging Information: 2000pcs Per Reel

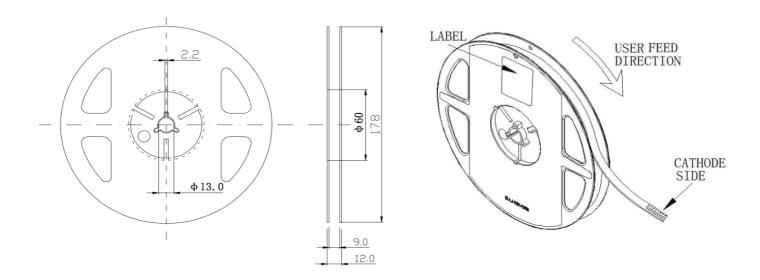
Tape Dimension



Part No.	Dim. A	Dim. B	Dim. C	Q'ty/Reel
IN-P41TASRGB	4.7±0.10	1.4±0.10	1.1±0.10	3K

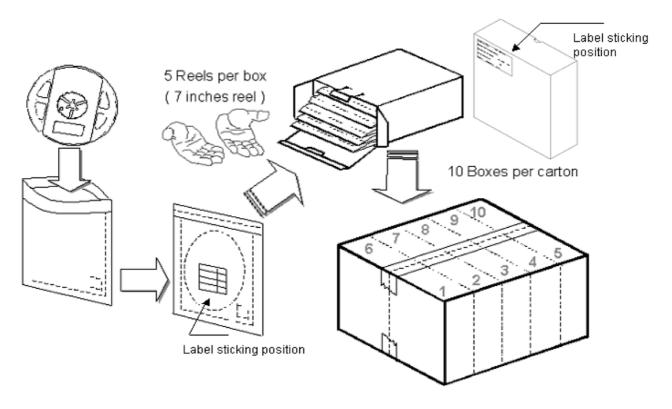
Unit: mm

Reel Dimension





Packing Dimension



5 boxes per carton are available depending on shipment quantity.

	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Conductive black tape	2000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	IN standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	IN standard	Paper	Non-specified

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

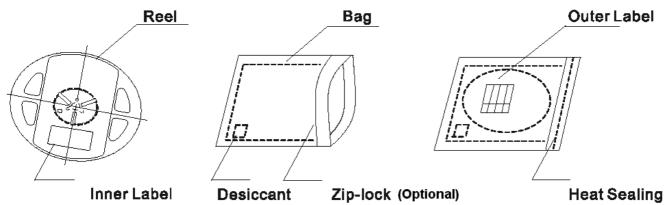


Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

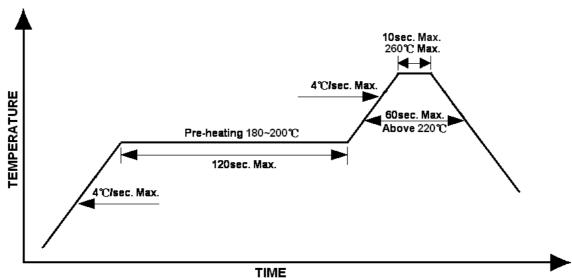
The packaging sequence is as follows:



Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

Lead-free Solder Profile





Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AllnGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- · Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.



Reliability

to JEDEC Level 2 168hrs 1Q/ 1/ 22/ 0 JESD22-B102-B And CNS-5068 Tinning speed: 2.5+0.5cm/s Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+ CNS-5067 Dipping soldering terminal only Soldering bath temperature A: 260+/-5°C; 10+/-1s B: 350+/-10°C; 3+/-0.5s 1Q/ 1/ 40/ 0 CNS-11829 1.) Precondition: 85°C baking for 24hrs 85°C/ 60%R.H. for 168hrs	Precondition Solderability Resistance to	failures For all reliability monitoring tests according to JEDEC Level 2	Reference J-STD-020	1.) Baking at 85°C for 24hrs 2.) Moisture storage at 85°C/ 60% R.H. for
For all reliability Precondition For all reliability Precondition For all reliability Precondition For all reliability For all reliability J-STD-020 1.) Baking at 85°C for 24hrs 2.) Moisture storage at 85°C/ 60% R.H. for 168hrs Accelerated aging 155°C/ 24hrs Tinning speed: 2.5+0.5cm/s Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+ CNS-5067 Dipping soldering terminal only Soldering bath temperature A: 260+/-5°C; 10+/-1s B: 350+/-10°C; 3+/-0.5s 1Q/ 1/ 40/ 0 CNS-11829 1.) Precondition: 85°C baking for 24hrs 85°C/ 60%R.H. for 168hrs	Precondition Solderability Resistance to	For all reliability monitoring tests according to JEDEC Level 2	J-STD-020	2.) Moisture storage at 85°C/ 60% R.H. for
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Operating life test 85°C/ 60%R.H. for 168hrs		10/ 1/ 40/ 0	CNS-11829	
	Operating life test			
I I Amp25°C' IE=2UMA' duration 1000n	sporating in a toot			2.) Tamb25°C; IF=20mA; duration 1000hrs
High humidity, 1Q/ 1/ 45/ 0 JESD-A101-B Tamb: 85°C	ligh humidity	10/ 1/ 45/ 0	JESD-A101-B	
high temperature Humidity: 85% R.H., IF=5mA			OLOD MIOT B	
bias Duration: 1000hrs				
10/ 1/ 20 IN space Tamb: 55°C		10/ 1/ 20	IN space	
High temperature 12/1/20 IT amb. 33 C IF=20mA	ligh temperature	e 197 17 20	пу эресэ.	
bias Duration: 1000hrs	oias			
1Q/ 1/ 40/ 0 Tamb25°C, If=20mA,, Ip=100mA, Duty		10/1/40/0		
Pulse life test cycle=0.125 (tp=125 μ s,T=1sec)	Ouloo lifo toot	10/ 1/ 40/ 0		
	ruise ille test			
Duration 500hrs)		10/1/70/0	1505 4404 4	
		1Q/ 1/ 76/ 0		A cycle: -40 degree C 15min; +85 degree C
Temperature IEC 68-2-14, Nb 15min	Temperature		IEC 68-2-14, Nb	
lovelo I nermai steady within 5 min	•			
Sou cycles	/y 010			
2 chamber/ Air-to-air type				
High humidity 1Q/ 1/ 40/ 0 CNS-6117 60+3°C		1Q/ 1/ 40/ 0	CNS-6117	
storage test 90+5/-10% R.H. for 500hrs				
High temperature 1Q/ 1/ 40/ 0 CNS-554 100+10°C for 500hrs		e 1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs
storage test	storage test			
Low temperature 1Q/ 1/ 40/ 0 CNS-6118 -40+5°C for 500hrs	ow temperature	e 1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs
storage test				



Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	04-05-2018

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